



**BBD-003-0491104**      Seat No. \_\_\_\_\_

**B. Sc. / M. Sc. (Applied Physics) (Sem. X)**  
**(CBCS) Examination**

**July - 2021**

**Paper-16 : Nanostructuring With Ion Beams**

*(Elective-4)*

*(New Course)*

**Faculty Code : 003**

**Subject Code : 0491104**

Time :  $2\frac{1}{2}$  Hours]

[Total Marks : 70

**Instructions :** Write any five questions.

**1** Write answer of following short questions : (**Two** marks each) **14**

- (1) Define a unit cell.
- (2) What are projected range and straggling of energetic ions in a target?
- (3) What is sputter erosion of materials by energetic ions?
- (4) What is Ehrlich-Schwoebel barrier?
- (5) Define parallel and perpendicular-mode ripple patterns.
- (6) What happens to pattern formation when impurities are also incorporated onto the target surface during ion induced pattern fabrication?
- (7) What happens to pattern formation when concurrent azimuthal rotation (beside tilt) is also provided onto the target surface during ion induced pattern fabrication?

**2** Write answer of following short questions : (**Two** marks each) **14**

- (1) How can the cold cathode electron emission performance be improved from nanofaceted Si surfaces?
- (2) What is plasmonics? Give two examples where it can be applied efficiently.
- (3) List the name of different regimes of ion induced pattern formation?

- (4) What is meant by stopping cross-section?
- (5) List various types of defects formed during ion interaction with solids?
- (6) What is surface diffusion?
- (7) List various applications of nanostructuring with ion beams.
- 3** Write answers of following questions. **14**
- (1) Explain various crystal systems with necessary diagram in detail.
- (2) State how many Bravais lattices are known to exist and explain in detail how the translational symmetry of the Bravais lattice are classified.
- 4** Write answers of following questions. **14**
- (1) Draw schematic diagrams of Triclinic and Rhombohedral systems and show different angles as well as axes with their relationships. Give one each example of these two crystallographic systems.
- (2) State the difference(s) between a direct and an indirect band-gap semiconductor along with schematic diagrams and two examples each.
- 5** Write answers of following questions. **14**
- (1) Describe the advantages of ion-beam induced nano-patterning of materials and name all the parameters which can influence the pattern formation.
- (2) Give a detail description (through a parametric phase diagram) of pattern formation on Si by energetic ( $\leq 2$  keV) inert gas ions (e.g. Ar-ions) by varying incident angle of ions.
- 6** Write answers of following questions. **14**
- (1) What are the main competing processes during pattern formation? Explain it in terms of schematic diagrams.
- (2) What is a morphologically anisotropic surface? Describe three examples where morphological anisotropy leads to anisotropic physical properties.

- 7** Write answers of following questions. **14**
- (1) Draw a schematic diagram, showing all the processes involved in ion-beam induced fabrication of embedded nanoparticles in a thick substrate. You can start from  $t=0$  and show the processes as a function of increasing time.
  - (2) Describe two methods and provide examples (one each) to fabricate highly ordered regular patterns (by energetic ion beams) on semiconductor surfaces.
- 8** Write answers of following questions. **14**
- (1) Explain laser annealing with schematic diagram and its applications.
  - (2) Show a schematic diagram of cold cathode electron emission process and describe in detail how cold cathode electron emission takes place from a ion patterned nanofaceted Si surface.
- 9** Write answers of following questions. **14**
- (1) Discuss the optical anisotropy in self aligned nanoparticles.
  - (2) Describe the applications of patterned oxide films in resistive switching.
- 10** Write answers of following questions. **14**
- (1) Discuss Bradley-Harper (B-H) instability regime in pattern formation and surface evolution.
  - (2) Explain the phenomena of displacement cascades and generation of defects.
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